| © Copyright 2005. IPC, Bannock                                 | Material Composition Declaration<br>© Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both<br>international and Pan-American copyright conventions. |               |   |  | This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility. |              |          |                                 |                  |           |                 |           |
|--|---|---------------|---|--|---|--------------|----------|---------------------------------|------------------|-----------|-----------------|-----------|
| IPC Web Site for Information on<br>http://www.ipc.org/IPC-175x | IPC Web Site for Information on IPC-1752 Standard Form Ty<br>http://www.ipc.org/IPC-175x Distribu   |               |   | * Declaration Class *<br>Class 6 - RoHS Yes/No, Homogeneous Materi |   |              |          | als and Mfg Information         |                  |           |                 |           |
| Supplier Information   |   |               |   |  |   |              |          |                                 |                  |           |                 |           |
| Company name* Company unique ID                                |   |               |   | Unique ID Authority  |   |              |          | Response Date*                  |                  |           |                 |           |
| onsemi   | emi   |               |   |  |   |              |          |                                 | 2023-06-08       |           |                 |           |
| Contact Name   | Title - Contact   |               |   | P  | Phone - Contact*  |              |          |                                 | Email - Contact* |           |                 |           |
| Product-Env-Stewards   | luct-Env-Stewards Product Enviro Compliance   |               |   | NA   |   |              |          | Product-Env-Stewards@onsemi.com |                  |           |                 |           |
| uthorized Representative* Title - Representative               |   |               |   | Phone - Representative*  |   |              |          | Email - Representative*         |                  |           |                 |           |
| Product-Env-Stewards Product Enviro Compliance                 |   |               |   | NA   |   |              |          | Product-Env-Stewards@onsemi.com |                  |           |                 |           |
| Requester Item Number Mfr Iter                                 | n Number  | Mfr Item Name |   |  | Effective Date  | Version      | Ma       | Manufacturing Site              |                  | Veight*   | UOM             | Unit Type |
| NCV87  | 8716MT28TBG 80 mA Ultra-Low Ic<br>Low Dropout Linear  |               | Iq, Wide Input Volta<br>ar Voltage Regulato | age,<br>or   | 2023-06-08  |              | MY       | ¥1                              | 9                | 0.0       | mg              | Each      |
| Manufacturing Proccess Information                             |   |               |   |  |   |              |          |                                 |                  |           |                 |           |
| Terminal Plating / Grid Array Material                         | Terminal Plating / Grid Array Material Terminal Base Alloy J-S  |               | STD-020 MSL Rati                            | ing  | Peak Proce  | ss Body Temp | perature | Max Time at Peak                | Temperati        | ure Numbe | r of Reflow Cyc | les       |
| Matte Tin (Sn) - annealed CU Alloy 1                           |   |               |   |  | 260   | C            |          | 30                              | second           | ds 3      |                 |           |
| Comments   |   |               |   |  |   |              |          |                                 |                  |           |                 |           |
| level 1 - maximum time at peak temperature during s            | oldering is 10-30   | ) seconds     |   |  |   |              |          |                                 |                  |           |                 |           |
| For more information regarding material composition            | please refer to   | page 3        |   |  |   |              |          |                                 |                  |           |                 |           |

| RoHS Material Composition Declaration  |  |  |   | Declaration Type *                              | Detailed  |  |  |  |  |  |  |
|--|--|--|---|---|---|--|--|--|--|--|--|
| Directive 2015/863/EU amending RoHS<br>Directive 2011/65/EU  | RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DIBP). |  |   |   |   |  |  |  |  |  |  |
| cadmium, hexavalentchromium, polybrominate<br>contains a RoHS restricted substance inexcess<br>encompass all such components. Supplier certif<br>as of the date that Supplier completes this form<br>Company acknowledges that Supplier may hav<br>independently verified information provided by<br>certification in this paragraph. If the Company a | ed biphenyls and/or polybrominated dip<br>of an applicable quantity limit, please ir<br>ies that it gathered the information it pro-<br>.Supplier acknowledges that Company<br>e relied on informationprovided by othe<br>v others, Supplier agrees that, at a minin<br>and the Supplier enter into a written agre<br>pource of the Supplier's liability and the   | henyl ethers (each a "<br>ndicate below which, i<br>ovides in this form us<br>will rely on this certifiers<br>in completing this<br>num, itssuppliers have<br>eement with respect to<br>Company's remedies | RoHS restricted substance") in exce<br>if any, RoHS exemption you believe<br>ing appropriate methods to ensure if<br>ication in determining the complian<br>form, and that Supplier may not have<br>e provided certifications regarding the<br>to the identified part, the terms and co<br>for issues that arise regarding inform | ce of its products with European Union membe    | ove. If a homogeneous material within the part<br>er level components, the declaration shall<br>l correct to the best of its knowledge and belief,<br>r state laws that implement the RoHS Directive.<br>wever, in situations where Supplier has not<br>tions are at least as comprehensive as the<br>anty rights and/or remedies provided as part of |  |  |  |  |  |  |
| RoHS Declaration * 1 - Item(s)   | does not contain RoHS restricted substa  | on above   | Supplier Acceptance   | * Accepted                                      |   |  |  |  |  |  |  |
| Exemption: If the declared item does not con applicable exemptions.  | ntain RoHS restricted substances per   | the definition above   | except for defined RoHS exempti   | ons, then select the corresponding response i   | n the RoHS Declaration above and choose all   |  |  |  |  |  |  |
| Exemption List Version   | EL-2011/534/EU   |  |   |   |   |  |  |  |  |  |  |
| Declaration Signature  |  |  |   |   |   |  |  |  |  |  |  |
| Instructions: Complete all of the required fin<br>Requester) and click on Submit Form to have  | elds on all pages of this form. Select the form returned to the Requester  | he "Accepted" on th  | e Supplier Acceptance drop-down   | . This will display the signature area. Digital | lly sign the declaration (if required by the  |  |  |  |  |  |  |
| Supplier Digital Signature Ra  | stislav Drska  | Le   |   |   |   |  |  |  |  |  |  |

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

| Iomogeneous Material Weight |      | Unit of Measure | Level    | Substance  | CAS         | Exempt | Weight | Unit of Measure |
|-----------------------------|------|-----------------|----------|--|-------------|--------|--------|-----------------|
| Die                         | 0.7  | mg              | Supplier | Silicon (Si)   | 7440-21-3   |        | 0.7    | mg              |
| Die Attach                  | 0.19 | mg              | Supplier | Epoxized Condensate Of Para-<br>Hydrobenzaldehyde And Alkyl Phenol | 129915-35-1 |        | 0.038  | mg              |
|                             |      |                 | Supplier | Silver (Ag)  | 7440-22-4   |        | 0.152  | mg              |
| Lead Frame                  | 3.1  | mg              | Supplier | Silver (Ag)  | 7440-22-4   |        | 0.031  | mg              |
|                             |      |                 | Supplier | Tin (Sn)   | 7440-31-5   |        | 0.0077 | mg              |
|                             |      |                 | Supplier | Zinc (Zn)  | 7440-66-6   |        | 0.0068 | mg              |
|                             |      |                 | Supplier | Chromium (Cr)  | 7440-47-3   |        | 0.0077 | mg              |
|                             |      |                 | Supplier | Copper (Cu)  | 7440-50-8   |        | 3.0467 | mg              |
| Mold Compound-Black         | 4.65 | mg              | Supplier | Epoxy and Phenolic Resin   | 40216-08-8  |        | 0.372  | mg              |
|                             |      |                 | Supplier | Carbon Black (C)   | 1333-86-4   |        | 0.0233 | mg              |
|                             |      |                 | Supplier | Aluminum Hydroxide (Al(OH)3)                                       | 21645-51-2  |        | 0.093  | mg              |
|                             |      |                 | Supplier | Fused Silica (SiO2)  | 60676-86-0  |        | 4.0223 | mg              |
|                             |      |                 | Supplier | Phenolic Resin (Novolac)   | 9003-35-4   |        | 0.1395 | mg              |
| Plating                     | 0.18 | mg              | Supplier | Tin (Sn)   | 7440-31-5   |        | 0.18   | mg              |
| Wire Bond - Au              | 0.18 | mg              | Supplier | Gold (Au)  | 7440-57-5   |        | 0.18   | mg              |

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).